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**ACCURATE DETERMINATION of TRANSPARENCY CURRENT in PACKAGED
SEMICONDUCTOR LASERS and SEMICONDUCTOR OPTICAL AMPLIFIERS**

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Abstract

We demonstrate a novel optical technique which can accurately measure the transparency current of packaged semiconductor lasers and optical amplifiers.

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The reliability of semiconductor laser diodes and related devices is a significant issue for their deployment in many applications [1,2], creating demand for device diagnostics applicable to packaged devices. Measurements of the transparency current density (J_0) in laser diodes and traveling-wave semiconductor optical amplifiers (SOAs) can provide such a diagnostic. It is essential, however, to measure J_0 on packaged devices, so that they can be characterized after aging or degradation. This precludes techniques requiring data from multiple devices (e.g., an ensemble with different lengths). J_0 is conventionally measured using a junction-voltage technique [3,4], in which an input optical signal induces a change in carrier density in the active region due to stimulated absorption or emission. The result is a voltage drop across the diode. At material transparency, the stimulated absorption is exactly balanced by the stimulated emission and the voltage drop goes to zero. Since the polarity of the voltage drop changes sign at current densities above J_0 , the optical input beam is typically modulated and lock-in amplification is employed to sensitively detect the polarity sign flip. Here we show that this technique is not reliable for certain types of laser structures, because the deduced J_0 is strongly dependent on device packaging--that is, the measured J_0 varies with the manner in which light is coupled into the diode waveguide. For packaged SOAs, we propose and demonstrate an alternative all-optical technique to overcome this problem. One important advantage of the optical method over the junction voltage method is that the actual device optically-guided mode is directly sampled. In the case of packaged semiconductor lasers, our all-optical method can complement the junction-voltage method to resolve device versus packaging degradation.

The essence of our all-optical technique for determining J_0 is shown in Fig. 1. A modulated (e.g., chopped at 350 Hz) pump beam (at λ_{pump}) is coupled into facet 1 of a laser diode or SOA. Below the transparency current density (J_0) the pump beam will saturate the absorption and increase the transmission for a second laser beam (at λ_{probe}) or for the amplified spontaneous emission (ASE) generated in the test device. At current densities greater than J_0 the pump beam will saturate the material gain and thereby decrease the transmission for other optical signals in the guided-wave device. At exactly J_0 , the pump beam does not modulate the other optical signal beams because neither saturable absorption or gain is present. Typically, the monitor signals are spectrally filtered in an optical spectrum analyzer (OSA, Hewlett-Packard 71451A) and detected with a lock-in amplifier. Since the semiconductor gain media are homogeneously-broadened, this method is largely insensitive to the wavelength of the detected light (J_0 for λ_{pump} is being measured). Several laser diodes and SOAs have been carefully characterized and a comparison of results obtained using a tunable probe beam as well as ASE at different center wavelengths and bandwidths show that the technique is sensitive and reproducible.

Fig. 1: Setup for measuring the transparency current of a laser diode or SOA using saturation-induced crosstalk. An optical spectrum analyzer (OSA) is utilized to spectrally filter the desired optical monitor signal: either forward or backward ASE or a weak probe beam ($\lambda_{\text{probe}} \neq \lambda_{\text{pump}}$) in the forward direction. At J_0 , no pump-induced modulation of the optical monitor signal occurs because neither saturable absorption or gain is present.

Figure 2A shows optical spectra for our InGaAs/GaAs SQW GRINSCH semiconductor optical amplifier. Conically-polished single-mode fibers are aligned with precision translation stages and a pump beam is input into Facet 1 at a wavelength corresponding to the SOA gain peak (891 nm). A chip gain of 30 dB is obtained at 100 ma for this 1 mm long device. Figure 2B shows a portion of the crosstalk versus current curve for this SOA. This plot (Fig. 2B), generated by detecting ASE at 922 nm (filter bandwidth=1 nm), shows that transparency occurs at 36 ma. For comparison, the junction-voltage technique indicates transparency at 28 ma. This is a moderate difference -- at a bias of 100 ma, a gain of 30 dB is inferred in the first case and 34 dB in the latter case. The 30 db chip gain inferred from our new technique agrees well with the directly measured chip gain (fiber to fiber gain - coupling losses). The reason for the lower junction-voltage result is not fully understood. No significant change in J_0 is observed for different positions of the input coupling fiber (this effect is structure-dependent, see below).

Fig. 2: A. Output spectra of SQW GRINSCH SOA with injected signal (891 nm) at transparency ($J=J_0$) and at 30 dB chip gain ($J=J_{30dB}$). B. Optical crosstalk as a function of the SOA bias current. At transparency, the SOA-generated ASE ceases to be modulated by the chopped pump beam.

Figure 3A shows a comparison of the optical crosstalk and junction-voltage methods for determining J_0 as a function of the lateral (in the plane of the junction) position of the input fiber coupled to a commercial laser diode (Sharp LT015). Note that when the input fiber is optimally coupled, the junction-voltage and optical crosstalk methods agree to better than 10%. However, as the fiber is displaced in the plane of the junction, the optical method shows an increase in J_0 whereas the junction-voltage method shows a large decrease.

Fig. 3: A. Comparison of the junction-voltage and optical crosstalk methods for measuring transparency. B. V-channelled substrate inner stripe (VSIS) laser diode. Sharp Corp., S. Yamamoto et al., *Appl. Phys. Lett.* 40, 972 (1982).

One plausible argument for the transparency current dependence on horizontal displacement of the injected light is as follows. We refer to Fig. 3B showing the current blocking layers (CBL) of the Sharp laser diode. For the case of the optical method of determining J_0 , the current density decreases laterally along the active region. These regions are pumped less so the overall current needs to be increased in order to reach transparency. The transparency current therefore increases with lateral displacement of the injected light. For the case of the junction-voltage method, the CBL region absorbs the injected light as it is horizontally displaced. The reverse bias junctions of the CBL act as photodiodes and thus a net excess of holes on the p-side of the active region tends to increase the forward current, thereby reducing the current needed from the external supply. This explanation requires further study. A very similar lateral J_0 dependence has also been observed in another commercial laser diode which has a different device structure (Hitachi HLP1400, channel substrate planar).

The solid curve in Fig. 3A plots the average of the two transparency methods. This averaged parameter is relatively insensitive to the input fiber coupling and closely represents the true transparency current density. By making both measurements and tracking the changes over time, one can determine whether performance degradations originate in the device or the fiber-coupled package. The optical technique for measuring transparency described here works well for both semiconductor lasers and optical amplifiers because access to only one optical facet is required. Additional information concerning the longitudinal distribution of gain anomalies (defects) may be obtained by comparing the measured J_0 from opposite ends of a device with both facets accessible (details will be presented at the conference).

In conclusion, we have demonstrated a new all-optical technique for measuring the transparency current of semiconductor lasers and optical amplifiers. For SOAs, the technique is deemed superior to the junction voltage method because the measurement is performed on the actual optically guided-mode of interest. This has particular relevance to packaged devices since we have shown that in some structures the measured J_0 is dependent upon the alignment of the fiber pigtail. Finally, monitoring J_0 over time using both the optical and voltage methods can provide a simple method for tracking the aging of packaged SOA and laser devices.

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